# Notice for TAIYO YUDEN Products

Please read this notice before using the TAIYO YUDEN products.

## /!\ REMINDERS

Product information in this catalog is as of October 2017. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

- Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available.
- Please conduct validation and verification of our products in actual condition of mounting and operating environment before using our products.
- The products listed in this catalog are intended for use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC) and medical equipment classified as Class I or II by IMDRF. Please be sure to contact TAIYO YUDEN for further information before using the products for any equipment which may directly cause loss of human life or bodily injury (e.g., transportation equipment including, without limitation, automotive powertrain control system, train control system, and ship control system, traffic signal equipment, disaster prevention equipment, medical equipment classified as Class III by IMDRF, highly public information network equipment including, without limitation, telephone exchange, and base station).

Please do not incorporate our products into any equipment requiring high levels of safety and/or reliability (e.g., aerospace equipment, aviation equipment\*, medical equipment classified as Class IV by IMDRF, nuclear control equipment, undersea equipment, military equipment).

\*Note: There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.

When our products are used even for high safety and/or reliability-required devices or circuits of general electronic equipment, it is strongly recommended to perform a thorough safety evaluation prior to use of our products and to install a protection circuit as necessary.

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

- Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.
- Please note that the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a fault or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement.
- The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.
- Caution for Export

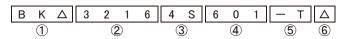
Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

# MULTILAYER CHIP BEAD INDUCTORS (BK ARRAY SERIES)



#### ■PARTS NUMBER

\* Operating Temp.:-55~+125°C



 $\Delta$ =Blank space

4 Nominal impedance

(example)

601

102

1	_			
(1)	Ser	ıes	nar	ne

Code	Series name
BK△	Multilayer chip bead inductor

#### ②Dimensions (L × W)

Code	Type (inch)	Dimensions (L×W)[mm]
2010	2010 (0804)	2.0 × 1.0
3216	3216(1206)	3.2 × 1.6

5 Packaging	
Code	Packaging
_T	Taping

Nominal impedance [  $\Omega$  ]

600

1000

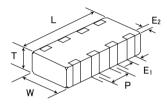
#### 3Material

Code	Material
4W	
4S	Refer to impedance curves
4M	for material differences
4L	

### 6 Internal code

_	
Code	Internal code
Δ	Standard

#### ■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



		L W T	Т	E <sub>1</sub>	E <sub>2</sub>		Standard quantity [pcs]	
Type L	Danar tana						Embossed	
			Paper tape				tape	
BK 2010	2.0±0.15	1.0±0.15	0.45±0.05	0.25+0.15/-0.1	$0.25 \pm 0.15$	$0.5 \pm 0.1$	4000	
(0804)	$(0.079 \pm 0.006)$	$(0.039 \pm 0.006)$	$(0.018 \pm 0.002)$	(0.010 + 0.006 / -0.004)	$(0.010\pm0.006)$	$(0.020\pm0.004)$	4000	_
BK 3216	3.2±0.2	1.6±0.2	0.8±0.1	0.35±0.2	$0.3 \pm 0.2$	0.8±0.1		4000
(1206)	$(0.126 \pm 0.008)$	$(0.063 \pm 0.008)$	$(0.031 \pm 0.004)$	$(0.014 \pm 0.008)$	(0.012±0.008)	$(0.031 \pm 0.004)$	_	4000
								/ı \

Unit:mm(inch)

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#### BK 2010

Parts number	EHS	Nominal impedance [Ω]	Impedance tolerance	Measuring frequency [MHz]	DC Resistance $[\Omega]$ (max.)	Rated current [mA] (max.)
BK 20104W680-T	RoHS	68	±25%	100	0.35	100
BK 20104W121-T	RoHS	120	±25%	100	0.40	100
BK 20104W241-T	RoHS	240	±25%	100	0.50	100
BK 20104S121-T	RoHS	120	±25%	100	0.30	100
BK 20104S241-T	RoHS	240	±25%	100	0.45	100
BK 20104S431-T	RoHS	430	±25%	100	0.55	100
BK 20104S601-T	RoHS	600	±25%	100	0.70	100
BK 20104M121-T	RoHS	120	±25%	100	0.30	100
BK 20104M241-T	RoHS	240	±25%	100	0.45	100
BK 20104M431-T	RoHS	430	±25%	100	0.55	100
BK 20104M601-T	RoHS	600	±25%	100	0.70	100
BK 20104M102-T	RoHS	1000	±25%	100	0.80	100
BK 20104L050-T	RoHS	5	±25%	100	0.10	100
BK 20104L100-T	RoHS	10	±25%	100	0.15	100
BK 20104L220-T	RoHS	22	±25%	100	0.20	100
BK 20104L330-T	RoHS	33	±25%	100	0.30	100
BK 20104L470-T	RoHS	47	±25%	100	0.40	100
BK 20104L680-T	RoHS	68	±25%	100	0.50	100
BK 20104L121-T	RoHS	120	±25%	100	0.70	100
BK 20104L181-T	RoHS	180	±25%	100	0.90	100

#### BK 3216

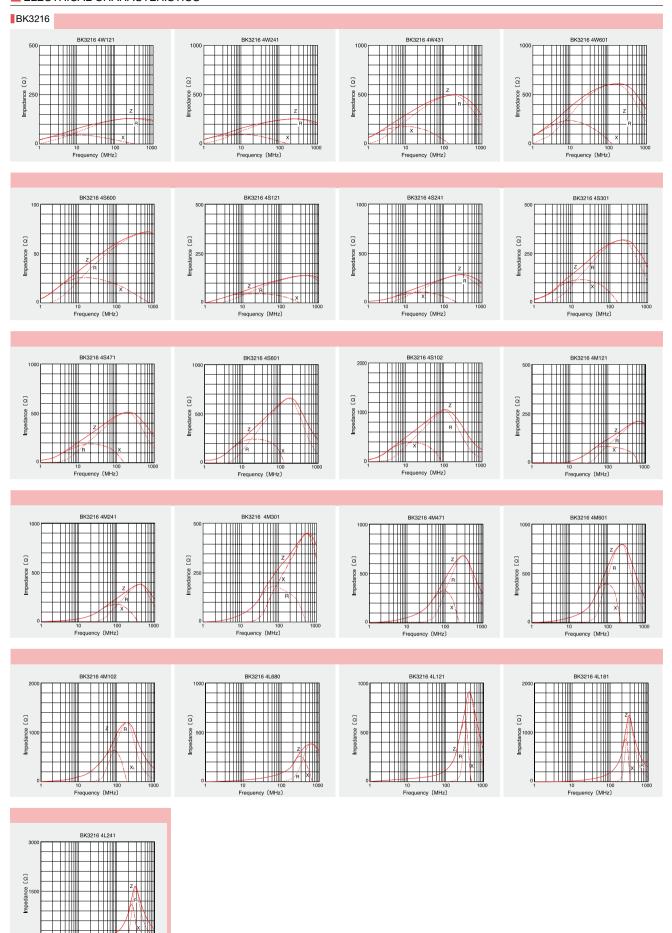
Parts number	EHS	Nominal impedance $\left[\Omega ight]$	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [mA] (max.)
BK 32164W121-T	RoHS	120	±25%	100	0.15	100
BK 32164W241-T	RoHS	240	±25%	100	0.25	100
BK 32164W431-T	RoHS	430	±25%	100	0.35	100
BK 32164W601-T	RoHS	600	±25%	100	0.40	100
BK 32164S600-T	RoHS	60	±25%	100	0.18	200
BK 32164S121-T	RoHS	120	±25%	100	0.18	200
BK 32164S241-T	RoHS	240	±25%	100	0.30	200
BK 32164S301-T	RoHS	300	±25%	100	0.40	200
BK 32164S471-T	RoHS	470	±25%	100	0.40	200
BK 32164S601-T	RoHS	600	±25%	100	0.45	200
BK 32164S102-T	RoHS	1000	±25%	100	0.68	100
BK 32164M121-T	RoHS	120	±25%	100	0.20	150
BK 32164M241-T	RoHS	240	±25%	100	0.35	150
BK 32164M301-T	RoHS	300	±25%	100	0.45	150
BK 32164M471-T	RoHS	470	±25%	100	0.50	150
BK 32164M601-T	RoHS	600	±25%	100	0.60	100
BK 32164M102-T	RoHS	1000	±25%	100	0.80	100
BK 32164L680-T	RoHS	68	±25%	100	0.35	200
BK 32164L121-T	RoHS	120	±25%	100	0.55	200
BK 32164L181-T	RoHS	180	±25%	100	0.65	150
BK 32164L241-T	RoHS	240	±25%	100	0.75	150

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Frequency (MHz)



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# Multilayer chip inductors

Multilayer chip inductors for high frequency, Multilayer chip bead inductors

Multilayer common mode choke coils (MC series F type)

Metal Multilayer Chip Power Inductors (MCOIL™ MC series)

PACKAGING

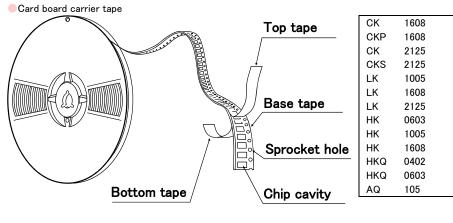
### 1 Minimum Quantity

Tape & Reel Packaging

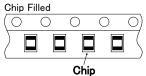
Tape & Reel Packaging			
Type	Thickness		uantity [pcs]
	mm(inch)	Paper Tape	Embossed Tape
CK1608(0603)	0.8 (0.031)	4000	_
CK2125 (0805)	0.85(0.033)	4000	_
	1.25(0.049)	_	2000
CKS2125 (0805)	0.85(0.033)	4000	_
	1.25(0.049)	_	2000
CKP1608 (0603)	0.8 (0.031)	4000	_
CKP2012 (0805)	0.9 (0.035)	_	3000
CKP2016 (0806)	0.9 (0.035)	_	3000
	0.7 (0.028)	_	3000
CKP2520 (1008)	0.9 (0.035)	_	3000
	1.1 (0.043)	_	2000
NM2012 (0805)	0.9 (0.035)	_	3000
NM2520(1008)	0.9 (0.035)	_	3000
141412020 (1000)	1.1 (0.043)	_	2000
LK1005(0402)	0.5 (0.020)	10000	_
LK1608(0603)	0.8 (0.031)	4000	_
LK2125 (0805)	0.85(0.033)	4000	_
LN2123(0003)	1.25(0.049)	_	2000
HK0603(0201)	0.3 (0.012)	15000	_
HK1005(0402)	0.5 (0.020)	10000	_
HK1608(0603)	0.8 (0.031)	4000	_
LU(040E (000E)	0.85(0.033)	_	4000
HK2125(0805)	1.0 (0.039)	_	3000
HKQ0402(01005)	0.2 (0.008)	20000	40000
HKQ0603W(0201)	0.3 (0.012)	15000	_
HKQ0603S(0201)	0.3 (0.012)	15000	_
HKQ0603U(0201)	0.3 (0.012)	15000	_
AQ105(0402)	0.5 (0.020)	10000	_
BK0402(01005)	0.2 (0.008)	20000	_
BK0603(0201)	0.3 (0.012)	15000	_
BK1005(0402)	0.5 (0.020)	10000	_
BKH0603(0201)	0.3 (0.012)	15000	_
BKH1005 (0402)	0.5 (0.020)	10000	_
BK1608(0603)	0.8 (0.031)	4000	_
Bit 1000 (0000)	0.85(0.033)	4000	_
BK2125(0805)	1.25(0.049)	_	2000
BK2010(0804)	0.45(0.018)	4000	_
BK3216(1206)	0.8 (0.031)	-	4000
BKP0402 (01005)	()	20000	-
BKP0603 (0201)	0.2 (0.008) 0.3 (0.012)	15000	_
BKP1005 (0402)	0.5 (0.020)	10000	_
BKP1608 (0603)	0.8 (0.031)	4000	
BKP2125 (0805)		4000	
	0.85 (0.033)		
MCF0605 (0202)	0.3 (0.012)	15000	10000
MCF0806 (0302)	0.4 (0.016)	_	10000
MCF1210 (0504)	0.55(0.022)	_	5000
MCF2010(0804)	0.45 (0.018)	-	4000
MCFK1608(0603)	0.6 (0.024)	4000	_
MCFE1608 (0603)	0.65(0.026)	4000	_
MCKK1608 (0603)	1.0 (0.039)		3000
MCHK2012(0806)	0.8 (0.031)	4000	_
MCKK2012 (0805)	1.0(0.039)	_	3000

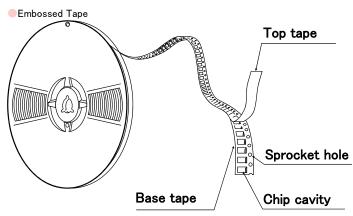
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## **2**Taping material



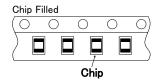
BK	0402	
BK	0603	
вк	1005	
BK	1608	
BK	2125	
BK	2010	
BKP	0402	
BKP	0603	
BKP	1005	
BKP	1608	
BKP	2125	
BKH	0603	
BKH	1005	
MCF	0605	
MC	1608	
MC	2012	



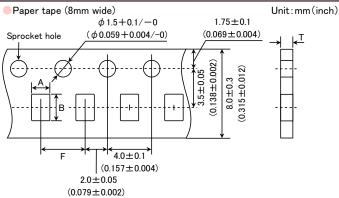


CK	2125	
CKS	2125	
CKP	2012	
CKP	2016	
CKP	2520	
NM	2012	
NM	2520	
LK	2125	
HKQ	0402	
HK	2125	

BK	2125	
BK	3216	
MCF	0806	
MCF	1210	
MCF	2010	
MC	1608	
MC	2012	



### **3**Taping Dimensions

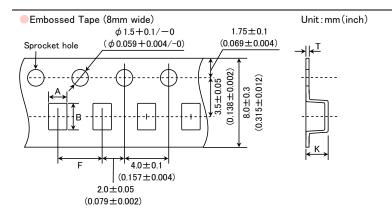


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_ Thickness		Chip	cavity	Insertion Pitch	Tape Thickness
Туре	mm(inch)	А	В	F	Т
CK1608(0603)	0.8 (0.031)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
	0.0 (0.001)	$(0.039 \pm 0.008)$	$(0.071 \pm 0.008)$	$(0.157 \pm 0.004)$	(0.043max)
CK2125(0805)	0.85(0.033)	1.5±0.2	2.3±0.2	4.0±0.1	1.1max
		(0.059±0.008)	$(0.091 \pm 0.008)$	(0.157±0.004)	(0.043max)
CKS2125 (0805)	0.85(0.033)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
		1.0±0.2	1.8±0.2	4.0±0.1	1.1max
CKP1608 (0603)	0.8 (0.031)	$(0.039 \pm 0.008)$	$(0.071 \pm 0.008)$	$(0.157 \pm 0.004)$	(0.043max)
L K100E (0400)	0.5 (0.000)	0.65±0.1	1.15±0.1	2.0±0.05	0.8max
LK1005 (0402)	0.5 (0.020)	$(0.026 \pm 0.004)$	$(0.045 \pm 0.004)$	$(0.079 \pm 0.002)$	(0.031max)
LK1608(0603)	0.8 (0.031)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
	0.0 (0.001)	$(0.039 \pm 0.008)$	$(0.071 \pm 0.008)$	(0.157±0.004)	(0.043max)
LK2125(0805)	0.85(0.033)	1.5±0.2 (0.059±0.008)	2.3±0.2	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
		0.40±0.06	(0.091±0.008) 0.70±0.06	2.0±0.05	0.45max
HK0603(0201)	0.3 (0.012)	(0.016±0.002)	$(0.028 \pm 0.002)$	$(0.079 \pm 0.002)$	(0.018max)
	/>	0.65±0.1	1.15±0.1	2.0±0.05	0.8max
HK1005(0402)	0.5 (0.020)	$(0.026 \pm 0.004)$	$(0.045 \pm 0.004)$	$(0.079 \pm 0.002)$	(0.031max)
HK1608(0603)	0.8 (0.031)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
HK1006(0003)	0.6 (0.031)	$(0.039 \pm 0.008)$	$(0.071 \pm 0.008)$	$(0.157 \pm 0.004)$	(0.043max)
HKQ0402(01005)	0.2 (0.008)	0.25±0.04	0.45±0.04	2.0±0.05	0.36max
	0.2 (0.000)	(0.010±0.002)	(0.018±0.002)	$(0.079 \pm 0.002)$	(0.014max)
HKQ0603W(0201)	0.3 (0.012)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
		(0.016±0.002)	(0.028±0.002)	(0.079±0.002)	(0.018max)
HKQ0603S(0201)	0.3 (0.012)	0.40±0.06 (0.016±0.002)	0.70±0.06 (0.028±0.002)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
		0.40±0.06	0.70±0.06	2.0±0.05	0.45max
HKQ0603U(0201)	0.3 (0.012)	(0.016±0.002)	$(0.028 \pm 0.002)$	$(0.079 \pm 0.002)$	(0.018max)
	( )	0.75±0.1	1.15±0.1	2.0±0.05	0.8max
AQ105(0402)	0.5 (0.020)	$(0.030 \pm 0.004)$	$(0.045 \pm 0.004)$	$(0.079 \pm 0.002)$	(0.031max)
BK0402(01005)	0.2 (0.008)	0.25±0.04	0.45±0.04	2.0±0.05	0.36max
BR0402 (01003)	0.2 (0.006)	(0.010±0.002)	(0.018±0.002)	$(0.079 \pm 0.002)$	(0.014max)
BK0603(0201)	0.3 (0.012)	$0.40 \pm 0.06$	0.70±0.06	2.0±0.05	0.45max
	0.0 (0.0.2)	(0.016±0.002)	$(0.028 \pm 0.002)$	(0.079±0.002)	(0.018max)
BK1005(0402)	0.5 (0.020)	0.65±0.1	1.15±0.1	2.0±0.05	0.8max
_		(0.026±0.004) 1.0±0.2	(0.045±0.004) 1.8±0.2	(0.079±0.002) 4.0±0.1	(0.031max) 1.1max
BK1608(0603)	0.8 (0.031)	$(0.039 \pm 0.008)$	$(0.071 \pm 0.008)$	$(0.157 \pm 0.004)$	(0.043max)
		1.5±0.2	2.3±0.2	4.0±0.1	1.1max
BK2125 (0805)	0.85(0.033)	$(0.059 \pm 0.008)$	$(0.091 \pm 0.008)$	$(0.157 \pm 0.004)$	(0.043max)
BK2010(0804)	0.45(0.018)	1.2±0.1	2.17±0.1	4.0±0.1	0.8max
BR2010(0004)	0.43(0.016)	$(0.047 \pm 0.004)$	$(0.085 \pm 0.004)$	$(0.157 \pm 0.004)$	(0.031max)
BKP0402(01005)	0.2 (0.008)	0.25±0.04	0.45±0.04	2.0±0.05	0.36max
	_ (======,	(0.010±0.002)	(0.018±0.002)	$(0.079 \pm 0.002)$	(0.014max)
BKP0603(0201)	0.3 (0.012)	0.40±0.06 (0.016±0.002)	0.70±0.06 (0.028±0.002)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
		0.65±0.1	1.15±0.1	2.0±0.05	0.8max
BKP1005(0402)	0.5 (0.020)	$(0.026 \pm 0.004)$	$(0.045 \pm 0.004)$	$(0.079 \pm 0.002)$	(0.031max)
DVD1600 (0600)	0.0 (0.001)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
BKP1608 (0603)	0.8 (0.031)	$(0.039 \pm 0.008)$	$(0.071 \pm 0.008)$	$(0.157 \pm 0.004)$	(0.043max)
BKP2125 (0805)	0.85(0.033)	1.5±0.2	2.3±0.2	4.0±0.1	1.1max
	5.55 (5.550)	$(0.059 \pm 0.008)$	$(0.091 \pm 0.008)$	(0.157±0.004)	(0.043max)
BKH0603(0201)	0.3 (0.012)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
		(0.016±0.002)	(0.028±0.002)	(0.079±0.002)	(0.018max)
BKH1005(0402)	0.5 (0.020)	0.65±0.1 (0.026±0.004)	1.15±0.1 (0.045±0.004)	2.0±0.05 (0.079±0.002)	0.8max (0.031max)
		0.62±0.03	0.77±0.03	2.0±0.05	0.45max
MCF0605 (0202)	0.3 (0.012)	(0.02±0.00 (0.024±0.001)	$(0.030 \pm 0.001)$	$(0.079 \pm 0.002)$	(0.018max)
MOEK1000 (0000)	0.0 (0.004)	1.1±0.05	1.9±0.05	4.0±0.1	0.72max
MCFK1608 (0603)	0.6 (0.024)	$(0.043\pm0.002)$	$(0.075 \pm 0.002)$	$(0.157 \pm 0.004)$	(0.028max)
MCFE1608(0603)	0.65(0.026)	1.1±0.05	1.9±0.05	4.0±0.1	0.9max
MOI L1000 (0003)	0.03 (0.020)	$(0.043 \pm 0.002)$	$(0.075 \pm 0.002)$	(0.157±0.004)	(0.035max)
MCHK2012 (0805)	0.8 (0.031)	1.55±0.2	2.3±0.2	4.0±0.1	0.9max
-	<u> </u>	$(0.061 \pm 0.008)$	$(0.091 \pm 0.008)$	$(0.157 \pm 0.004)$	(0.035max)

Unit: mm(inch)

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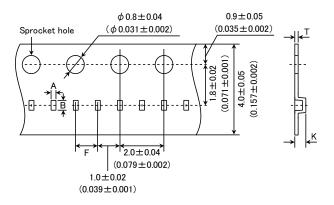
-	Thickness	Chip	cavity	Insertion Pitch	Tape Thickness		
Type mm(inch)		А	В	F	K	Т	
OV010E (000E)	1.05(0.040)	1.5±0.2	2.3±0.2	4.0±0.1	2.0	0.3	
CK2125 (0805)	1.25(0.049)	$(0.059 \pm 0.008)$	$(0.091 \pm 0.008)$	$(0.157 \pm 0.004)$	(0.079)	(0.012)	
OV0010E (000E)	1.05(0.040)	1.5±0.2	2.3±0.2	4.0±0.1	2.0	0.3	
CKS2125 (0805)	1.25(0.049)	$(0.059 \pm 0.008)$	$(0.091 \pm 0.008)$	$(0.157 \pm 0.004)$	(0.079)	(0.012)	
OKD0010 (000E)	0.9 (0.035)	1.55±0.2	2.3±0.2	4.0±0.1	1.3	0.3	
CKP2012 (0805)	0.9 (0.035)	$(0.061 \pm 0.008)$	$(0.091 \pm 0.008)$	$(0.157 \pm 0.004)$	(0.051)	(0.012)	
CKP2016 (0806) 0.9 (0.035)		1.8±0.1	2.2±0.1	4.0±0.1	1.3	0.25	
CKP2010 (0800)	0.9 (0.035)	$(0.071 \pm 0.004)$	$(0.087 \pm 0.004)$	$(0.157 \pm 0.004)$	(0.051)	(0.01)	
	0.7 (0.000)				1.4		
	0.7 (0.028)				(0.055)		
OKD0E00 (1000)	0.0 (0.035)	2.3±0.1	2.8±0.1	$4.0 \pm 0.1$	1.4	0.3	
CKP2520 (1008)	0.9 (0.035)	$(0.091 \pm 0.004)$	$(0.110 \pm 0.004)$	$(0.157 \pm 0.004)$	(0.055)	(0.012)	
	1.1 (0.042)				1.7		
	1.1 (0.043)				(0.067)		
NIMAGO 1 G (GGGE)	0.0 (0.005)	1.55±0.2	2.3±0.2	4.0±0.1	1.3	0.3	
NM2012 (0805)	0.9 (0.035)	$(0.061 \pm 0.008)$	$(0.091 \pm 0.008)$	$(0.157 \pm 0.004)$	(0.051)	(0.012)	
NM2520(1008)	0.9 (0.035)				1.4		
	0.9 (0.035)	2.3±0.1	2.8±0.1	4.0±0.1	(0.055)	0.3	
	1.1 (0.043)	$(0.091 \pm 0.004)$	$(0.110 \pm 0.004)$	$(0.157 \pm 0.004)$	1.7	(0.012)	
					(0.067)		
LK2125(0805)	1.05(0.040)	1.5±0.2	2.3±0.2	4.0±0.1	2.0	0.3	
	1.25(0.049)	$(0.059 \pm 0.008)$	$(0.091 \pm 0.008)$	$(0.157 \pm 0.004)$	(0.079)	(0.012)	
	0.05(0.000)				1.5		
	0.85(0.033)	1.5±0.2	2.3±0.2	4.0±0.1	(0.059)	0.3	
HK2125(0805)	4.0 (0.000)	$(0.059 \pm 0.008)$	$(0.091 \pm 0.008)$	$(0.157 \pm 0.004)$	2.0	(0.012)	
	1.0 (0.039)				(0.079)		
		1.5±0.2	2.3±0.2	4.0±0.1	2.0	0.3	
BK2125 (0805)	1.25(0.049)	$(0.059 \pm 0.008)$	$(0.091 \pm 0.008)$	$(0.157 \pm 0.004)$	(0.079)	(0.012)	
DI(0010(1000)	0.0(0.004)	1.9±0.1	3.5±0.1	4.0±0.1	1.4	0.3	
BK3216(1206)	0.8(0.031)	$(0.075 \pm 0.004)$	$(0.138 \pm 0.004)$	$(0.157 \pm 0.004)$	(0.055)	(0.012)	
14050000(0000)	0.4 (0.040)	0.75±0.05	0.95±0.05	2.0±0.05	0.55	0.3	
MCF0806(0302)	0.4 (0.016)	$(0.030 \pm 0.002)$	$(0.037 \pm 0.002)$	$(0.079 \pm 0.002)$	(0.022)	(0.012)	
	0.55 (0.000)	1.15±0.05	1.40±0.05	4.0±0.1	0.65	0.3	
MCF1210 (0504)	0.55 (0.022)	$(0.045 \pm 0.002)$	$(0.055 \pm 0.002)$	$(0.157 \pm 0.004)$	(0.026)	(0.012)	
	( )	1.1±0.1	2.3±0.1	4.0±0.1	0.85	0.3	
MCF2010(0804)	0.45 (0.018)	$(0.043\pm0.004)$	$(0.091 \pm 0.004)$	$(0.157 \pm 0.004)$	(0.033)	(0.012)	
		1.1±0.1	1.95±0.1	4.0±0.1	1.4	0.25	
MCKK1608(0603)	1.0 (0.039)	$(0.043 \pm 0.004)$	(±0.004)	$(0.157 \pm 0.004)$	(0.055)	(0.01)	
		1.55±0.2	2.3±0.2	4.0±0.1	1.35	0.25	
MCKK2012 (0805)	1.0 (0.039)	$(0.061 \pm 0.008)$	$(0.091 \pm 0.008)$	$(0.157 \pm 0.004)$	(0.053)	(0.010)	
	1	(0.001 = 0.000)	(0.001 = 0.000)	(0.107 = 0.004)	(0.000)		

Unit: mm(inch)

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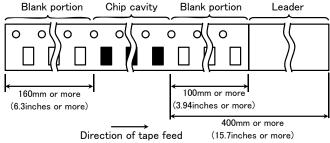
#### Embossed Tape (4mm wide)

#### Unit:mm(inch)

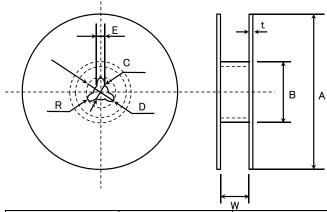


T	Thickness	Chip cavity		Insertion Pitch	Tape Th	nickness
Туре	mm(inch)	Α	В	F	K	Т
HKQ0402 (01005)	0.2 (0.008)	0.23	0.43	1.0±0.02	0.5max.	0.25max.
					Unit	: mm

# 4 LEADER AND BLANK PORTION



#### **5**Reel Size



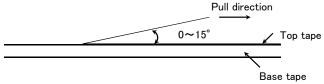
Α	В	С	D	E	R
$\phi$ 178 ± 2.0	$\phi$ 50 or more	$\phi$ 13.0 $\pm$ 0.2	$\phi$ 21.0 ± 0.8	2.0±0.5	1.0

	t	W
4mm width tape	1.5max.	5±1.0
8mm width tape	2.5max.	10±1.5

## (Unit : mm)

### **6**Top tape strength

The top tape requires a peel-off force of  $0.1 \sim 0.7 N$  in the direction of the arrow as illustrated below.



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# Multilayer chip inductors

Multilayer chip inductors for high frequency, Multilayer chip bead inductors

Multilayer common mode choke coils (MC series F type)

Metal Multilayer Chip Power Inductors (MCOIL™ MC series)

REL	Iabi	LITY	' DA	٩ТА

1. Operating Tempe	rature Range			
F	BK0402			
	BK0603			
	BK1005			
	BKH0603			
	BKH1005			
	BK1608			
	BK2125			
	BK2010			
	ARRAY	BK3216		
	BKP0402	BROZTO		
	BKP0603			
	BKP1005			
	BKP1608			
	BKP2125			
	MCF 0605			
	MCF 0806			
MCF 1210			-40~+85°C	
	MCF 2010			
	CK1608			
	CK2125			
	CKS2125			
Specified Value	CKP1608			
	CKP2012			
	CKP2016			
	CKP2520		-40~+85°C	
	NM2012			
	NM2520			
	LK1005		†	
	LK1608			
	LK2125		┪	
	HKQ0402			
	HK0603			
	HK1005		<b>-</b>	
	HK1608			
	HK2125		-40~+85°C	
	HKQ0603W/HKQ	0603S/HKQ0603U		
	AQ105			
	MCFK1608			
	MCFE1608			
	MCKK1608			
	MCHK2012		-40~+125°C (Including self-generated heat)	
			†	
	MCKK2012			

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0 Ct T	t D			
2. Storage Tempera	BK0402			
	BK0603			
	BK1005 BKH0603			
			FF 140500	
	BKH1005		55~+125°C	
	BK1608			
	BK2125	1		
	ARRAY	BK2010		
		BK3216		
	BKP0402			
	BKP0603			
	BKP1005			
	BKP1608			
	BKP2125			
	MCF 0605			
	MCF 0806		-40~+85°C	
	MCF 1210			
	MCF 2010			
	CK1608			
	CK2125			
Specified Value	CKS2125			
	CKP1608		_	
	CKP2012			
	CKP2016		-40∼+85°C	
	CKP2520			
	NM2012			
	NM2520			
	LK1005			
	LK1608			
	LK2125			
	HKQ0402			
	HK0603			
	HK1005			
	HK1608		-40~+85°C	
	HK2125		10 1000	
		KQ0603S/HKQ0603U		
	AQ105			
	MCFK1608			
	MCFE1608			
	MCKK1608		-40~+85°C	
	MCHK2012			
	MCKK2012			

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3. Rated Current					
	BK0402		150~750mA DC		
	BK0603		100~500mA DC		
	BK1005		120~1000mA DC		
	BKH0603		115~450mA DC		
	BKH1005		200~300mA DC		
	BK1608		150~1500mA DC		
	BK2125		200~1200mA DC		
	ARRAY	BK2010	100mA DC		
	ARRAT	BK3216	100~200mA DC		
	BKP0402		0.55~1.1A DC		
	BKP0603		0.8~1.8A DC		
	BKP1005		0.8~2.4A DC		
	BKP1608		1.0~3.0A DC		
	BKP2125		1.5~4.0A DC		
	MCF 0605		0.05A DC		
	MCF 0806		0.1~0.13A DC		
	MCF 1210		0.1~0.16A DC		
	MCF 2010		0.1A DC		
	CK1608		50~60mA DC		
	CK2125		60~500mA DC		
	CKS2125		110∼280mA DC		
Specified Value	CKP1608		0.35~0.9A DC		
Specified value	CKP2012		0.7~1.7A DC		
	CKP2016		0.9~1.6A DC		
	CKP2520		1.1~1.8A DC		
	NM2012		1.0~1.2A DC		
	NM2520		0.9~1.2A DC		
	LK1005		20~25mA DC		
	LK1608		1~150mA DC		
	LK2125		5~300mA DC		
	HK0603		60~470mA DC		
	HK1005		110~300mA DC (-55~+125°C) 200~900mA DC (-55~+85°C)		
	HK1608		150~300mA DC		
	HK2125		300mA DC		
	HKQ0402		100~500mA DC		
	HKQ0603W		100~850mA DC		
	HKQ0603S		130~600mA DC		
	HKQ0603U		190~900mA DC		
	AQ105		280~710mA DC		
	MCFK1608		Idc1 : 1500~2300mA DC, Idc2 : 900~2100mA DC		
	MCFE1608		Idc1 : 1400~2600mA DC, Idc2 : 800~1500mA DC		
	MCKK1608		Idc1 : 2800~2000mA DC		
	1		1		

### Definition of rated current:

MCHK2012

MCKK2012

- •In the CK, CKS and BK Series, the rated current is the value of current at which the temperature of the element is increased within 20°C.
- •In the BK Series P type, CK Series P type, NM Series, the rated current is the value of current at which the temperature of the element is increased within 40°C.
- •In the LK, HK, HKQ0603, and AQ Series, the rated current is either the DC value at which the initial L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 20°C.

 Idc1
 : 2260~4320mA DC,
 Idc2
 : 1470~3600mA DC

 Idc1
 : 3600~6200mA DC,
 Idc2
 : 2100~4000mA DC

- •In the HKQ0402(~9N1), the rated current is either the DC value at which the initial L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 20°C.
- •In the HKQ0402(10N~), the rated current is either the DC value at which the initial L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 25°C.
- •In the MC Series, Idc1 is the DC value at which the initial L value is decreased within 30% and Idc2 is the DC value at which the temperature of element is increased within 40°C by the application of DC bias. (at 20°C)

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### Specified Value    BC4029	4.7			
BRK003	4. Impedance	DICOADO		10 0000   50(100   050(01)
BR(1005				
BRH-0003				
BRH1005				
BR1606   22~5000 ± 25%				
BR2125				
### ARRAV				
ARRAY				
BRP0402		ARRAY		
BKP0603			3210	
BRY1005				
BRF0108   33~4709 ±29%   BRF0125   33~4309 ±29%   MCF 0905   12~909 ±501120, ±204030;2800,±25460;0   MCF 1910   40~900 ±204(21900),±254(0ther)   MCF 2101   50.000   50.000   MCF 2012   50.000   50.000   MCF 2014   50.000   50.000   MCF 2015   50.				
BRP2125   33~300 ± 29%				
MCF 0805				
MGF 1210   40 ~ 90 Ω ± 20 (219 0.0), ± 25 (20 0.0)     MGF 2010   50 Ω ± 20 (219 0.0), ± 25 (20 0.0), ± 25 (20 0.0)     MGF 2010   50 Ω ± 20 (219 0.0), ± 25 (20 0.0), ± 25 (20 0.0)     CK1698   70				
MCF 1210				
McF 2010				
Ck 1608				
CK2125				0011 120%
Specified Value				<del>-</del>
CKP1608				
CKP2012	Specified Value			
CKP2507				1
CKP2507				
NM2520				1
LK1005		NM2012		
LK1508		NM2520		
LK2125		LK1005		
HKQ0402		LK1608		
HK0603		LK2125		_
HK1005		HKQ0402		
HK1608		HK0603		
HK2125		HK1005		
HKQ0603K/HKQ0603S/HKQ0603U				
AQ105				
MCFK1608			S/HKQ0603U	
MCKK1608				
MCKK2012  MCKK2012  BK0402Series, BKP0402Series  Measuring frequency : 100±1MHz  Measuring ig : 16197A(or its equivalent)  Measuring frequency : 100±1MHz  Measuring ig : 16193A(or its equivalent)  Measuring ig : 16193A(or its equivalent)  Measuring ig : 16193A(or its equivalent)  Measuring frequency : 100±1MHz  Measuring ig : 16192A(or its equivalent), 16193A(or its equivalent)  Measuring frequency : 100±1MHz  Measuring frequency : 100±1MHz  Measuring frequency : 100±1MHz  Measuring ig : 16092A(or its equivalent) or 16192A(or its equivalent)/HW  Measuring frequency : 100±1MHz				_
MCKK2012  BK0402Series, BKP0402Series  Measuring frequency : 100±1MHz  Measuring equipment : E4991A(or its equivalent)  Measuring jig : 16197A(or its equivalent)  BK0603Series, BKP0603Series  Measuring frequency : 100±1MHz  Measuring equipment : 4291A(or its equivalent)  Measuring jig : 16193A(or its equivalent)  Measuring jig : 16193A(or its equivalent)  Measuring jig : 16193A(or its equivalent)  BK1005Series, BKP1005Series, BKH1005Series  Measuring frequency : 100±1MHz  Measuring gequipment : 4291A(or its equivalent), 16193A(or its equivalent)  Measuring jig : 16192A(or its equivalent), 16193A(or its equivalent)  Measuring frequency : 100±1MHz  Measuring gequipment : 4291A(or its equivalent), 16192A(or its equivalent)  Measuring jig : 16092A(or its equivalent), 16192A(or its equivalent)  Measuring jig : 16092A(or its equivalent) or 16192A(or its equivalent)/HW  BK2010·3216Series, MCF Series  Measuring frequency : 100±1MHz  Measuring frequency : 100±1MHz  Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)				_
BK0402Series, BKP0402Series				-
BK0402Series, BKP0402Series  Measuring frequency : 100±1MHz  Measuring gequipment : E4991A (or its equivalent)  Measuring jig : 16197A (or its equivalent)  BK0603Series, BKP0603Series  Measuring frequency : 100±1MHz  Measuring gequipment : 4291A (or its equivalent)  Measuring jig : 16193A (or its equivalent)  Measuring jig : 16193A (or its equivalent)  Measuring frequency : 100±1MHz  Measuring frequency : 100±1MHz  Measuring gequipment : 4291A (or its equivalent), 16193A (or its equivalent)  Measuring frequency : 100±1MHz  Measuring equipment : 4291A (or its equivalent), 4195A (or its equivalent)				-
Measuring frequency : 100±1MHz Measuring jig : 16197A(or its equivalent)  BK0603Series, BKP0603Series  Measuring frequency : 100±1MHz  Measuring frequency : 100±1MHz  Measuring gequipment : 4291A(or its equivalent)  Measuring jig : 16193A(or its equivalent)  Measuring frequency : 100±1MHz  Measuring frequency : 100±1MHz  Measuring frequency : 100±1MHz  Measuring frequency : 100±1MHz  Measuring gequipment : 4291A(or its equivalent), 16193A(or its equivalent)  Measuring jig : 16192A(or its equivalent), 16193A(or its equivalent)  Measuring frequency : 100±1MHz  Measuring frequency : 100±1MHz  Measuring gequipment : 4291A(or its equivalent), 4195A(or its equivalent)/HW  BK2010-3216Series, MCF Series  Measuring frequency : 100±1MHz  Measuring frequency : 4291A(or its equivalent), 4195A(or its equivalent)			125 orion	
Measuring equipment : E4991A(or its equivalent) Measuring jig : 16197A(or its equivalent) BK0603Series, BKP0603Series  Measuring frequency : 100±1MHz Measuring jig : 16193A(or its equivalent) Measuring jig : 16193A(or its equivalent) Measuring jig : 16193A(or its equivalent) BK1005Series, BKP1005Series ,BKH1005Series  Measuring frequency : 100±1MHz Measuring equipment : 4291A(or its equivalent) Measuring jig : 16192A(or its equivalent), 16193A(or its equivalent) Measuring frequency : 100±1MHz Measuring frequency : 100±1MHz Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent) Measuring jig : 16092A(or its equivalent) or 16192A(or its equivalent) Measuring frequency : 100±1MHz Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)		,		
Measuring jig : 16197A(or its equivalent) BK0603Series, BKP0603Series  Measuring frequency : 100±1MHz Measuring giquipment : 4291A(or its equivalent) Measuring jig : 16193A(or its equivalent) Measuring jig : 16193A(or its equivalent) BK1005Series, BKP1005Series BKH1005Series BK1005Series, BKH1005Series Measuring frequency : 100±1MHz  Measuring gequipment : 4291A(or its equivalent), 16193A(or its equivalent) Measuring jig : 16192A(or its equivalent), 16193A(or its equivalent) BK1608·2125Series, BKP1608·2125Series Measuring frequency : 100±1MHz Measuring jig : 16092A(or its equivalent), 4195A(or its equivalent)/HW BK2010·3216Series, MCF Series Measuring frequency : 100±1MHz Measuring frequency : 100±1MHz Measuring frequency : 100±1MHz Measuring frequency : 100±1MHz Measuring frequency : 4291A(or its equivalent), 4195A(or its equivalent)				uivalent)
BK0603Series, BKP0603Series  Measuring frequency : 100±1MHz  Measuring equipment : 4291A(or its equivalent)  Measuring jig : 16193A(or its equivalent)  BK1005Series, BKP1005Series BKH1005Series  Test Methods and Remarks  Measuring frequency : 100±1MHz  Measuring gequipment : 4291A(or its equivalent), 16193A(or its equivalent)  Measuring jig : 16192A(or its equivalent), 16193A(or its equivalent)  BK1608·2125Series, BKP1608·2125Series  Measuring frequency : 100±1MHz  Measuring frequency : 100±1MHz  Measuring jig : 16092A(or its equivalent) or 16192A(or its equivalent)/HW  BK2010·3216Series, MCF Series  Measuring frequency : 100±1MHz  Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)				
Measuring frequency : 100±1MHz Measuring equipment : 4291A(or its equivalent) Measuring jig : 16193A(or its equivalent) BK1005Series, BKP1005Series BKH1005Series  Test Methods and Remarks  Measuring frequency : 100±1MHz Measuring equipment : 4291A(or its equivalent) Measuring jig : 16192A(or its equivalent), 16193A(or its equivalent) BK1608·2125Series, BKP1608·2125Series Measuring frequency : 100±1MHz Measuring frequency : 100±1MHz Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent) Measuring jig : 16092A(or its equivalent) or 16192A(or its equivalent)/HW BK2010·3216Series, MCF Series Measuring frequency : 100±1MHz Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent) Measuring frequency : 100±1MHz Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)				
Measuring equipment : 4291A(or its equivalent) Measuring jig : 16193A(or its equivalent) BK1005Series, BKP1005Series ,BKH1005Series  Test Methods and Remarks  Measuring frequency : 100±1MHz Measuring jig : 16192A(or its equivalent) Measuring jig : 16192A(or its equivalent) Measuring frequency : 100±1MHz  Measuring jig : 16092A(or its equivalent) or 16192A(or its equivalent)/HW  BK2010•3216Series, MCF Series  Measuring frequency : 100±1MHz  Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)  Measuring frequency : 100±1MHz  Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)				
BK1005Series, BKP1005Series ,BKH1005Series  Test Methods and Remarks  Measuring frequency : 100±1MHz  Measuring jig : 16192A(or its equivalent), 16193A(or its equivalent)  BK1608•2125Series, BKP1608•2125Series  Measuring frequency : 100±1MHz  Measuring frequency : 100±1MHz  Measuring jig : 16092A(or its equivalent), 4195A(or its equivalent)/HW  BK2010•3216Series, MCF Series  Measuring frequency : 100±1MHz  Measuring frequency : 100±1MHz  Measuring frequency : 100±1MHz  Measuring frequency : 4291A(or its equivalent), 4195A(or its equivalent)			: 4291A (or its equi	ivalent)
Test Methods and Remarks  Measuring frequency : 100±1MHz  Measuring jig : 16192A(or its equivalent), 16193A(or its equivalent)  BK1608·2125Series, BKP1608·2125Series  Measuring frequency : 100±1MHz  Measuring frequency : 100±1MHz  Measuring jig : 16092A(or its equivalent), 4195A(or its equivalent)  Measuring jig : 16092A(or its equivalent) or 16192A(or its equivalent)/HW  BK2010·3216Series, MCF Series  Measuring frequency : 100±1MHz  Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)  Measuring frequency : 100±1MHz  Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)				uivalent)
Remarks  Measuring equipment : 4291A(or its equivalent) Measuring jig : 16192A(or its equivalent), 16193A(or its equivalent) BK1608 • 2125Series, BKP1608 • 2125Series  Measuring frequency : 100±1MHz Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent) Measuring jig : 16092A(or its equivalent) or 16192A(or its equivalent)/HW BK2010 • 3216Series, MCF Series Measuring frequency : 100±1MHz Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)				
Measuring jig : 16192A(or its equivalent), 16193A(or its equivalent)  BK1608•2125Series, BKP1608•2125Series  Measuring frequency : 100±1MHz  Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)  Measuring jig : 16092A(or its equivalent) or 16192A(or its equivalent)/HW  BK2010•3216Series, MCF Series  Measuring frequency : 100±1MHz  Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)				
BK1608 • 2125Series, BKP1608 • 2125Series  Measuring frequency : 100±1MHz  Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)  Measuring jig : 16092A(or its equivalent) or 16192A(or its equivalent)/HW  BK2010 • 3216Series, MCF Series  Measuring frequency : 100±1MHz  Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)	Remarks			
Measuring frequency : 100±1MHz Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent) Measuring jig : 16092A(or its equivalent) or 16192A(or its equivalent)/HW BK2010•3216Series, MCF Series Measuring frequency : 100±1MHz Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)				uivalent), 16193A(or its equivalent)
Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)  Measuring jig : 16092A(or its equivalent) or 16192A(or its equivalent)/HW  BK2010•3216Series, MCF Series  Measuring frequency : 100±1MHz  Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)				
Measuring jig : 16092A(or its equivalent) or 16192A(or its equivalent)/HW BK2010•3216Series, MCF Series Measuring frequency : 100±1MHz Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)				ivalent) 4195A(or its equivalent)
BK2010•3216Series, MCF Series  Measuring frequency : 100±1MHz  Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)				
Measuring frequency : 100±1MHz Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)			· ·	analy of 101001(or to oquitalone)/1111
Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)				
Measuring jig : 16192A(or its equivalent)				ivalent), 4195A(or its equivalent)
		Measuring jig	: 16192A(or its equ	uivalent)

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5. Inductance			
	BK0402		
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		†
	BK2125		<del>-</del>
	BK2010		-
	ARRAY BK3216		
	BKP0402		-
	BKP0603		-
			-
	BKP1005 BKP1608		-
			-
	BKP2125		-
	MCF 0605		-
	MCF 0806		-
	MCF 1210		-
	MCF 2010		47 100 11 1000
	CK1608		4.7~10.0 µH: ±20%
	CK2125		0.1~10.0 µH: ±20%
	CKS2125		1.0~10.0 µH: ±20%
	CKP1608		0.33~2.2 µH: ±20%
Specified Value	CKP2012		0.47~4.7 µH: ±20%
	CKP2016		0.47~4.7 µH: ±20%
	CKP2520		0.47~4.7 µH: ±20%
	NM2012		0.82~1.0 µH: ±20%
	NM2520 LK1005		1.0~2.2 µH: ±20%
			0.12~2.2 μH: ±10 or 20%
	LK1608		0.047~33.0 \(\mu\)H: \(\pm\)20% \(0.10~12.0 \(\mu\)H: \(\pm\)10%
	LK2125		0.047~33.0 \(\mu\)H: \(\pm 20\)% \(0.10~12.0 \(\mu\)H: \(\pm 10\)%
	HK0603		1.0~6.2nH: ±0.3nH 6.8~100nH: ±5%
	HK1005		1.0~6.2nH: ±0.3nH 6.8~270nH: ±5%
	HK1608		1.0~5.6nH: ±0.3nH 6.8~470nH: ±5%
	HK2125		1.5~5.6nH: ±0.3nH 6.8~470nH: ±5%
	HKQ0402		0.5~3.9nH: ±0.1 or 0.2 or 0.3nH 4.3~5.6nH: ±0.3nH or 3% or 5%
			6.2~47nH: ±3 or 5%
	HKQ0603W		$0.6 \sim 3.9$ nH: $\pm 0.1$ or $0.2$ or $0.3$ nH $4.3 \sim 6.2$ nH: $\pm 0.2$ or $0.3$ nH or $3$ or $5\%$
	HKQ0603S		6.8~30nH: ±3 or 5% 33~100nH: ±5%
	HKQ0603U		0.6~6.2nH: ±0.2 or 0.3nH 6.8~22nH: ±3 or 5% 0.6~4.2nH: ±0.1 or 0.2 or 0.3nH 4.3~6.5nH: ±0.2 or 0.3nH 6.8~22nH: ±3 or 5%
	AQ105		1.0~6.2nH: ±0.3nH 6.8~15nH: ±5%
	MCFK1608		0.24~1.0 µH: ±20%
	MCFE1608		0.24~1.0 µH: ±20%
	MCKK1608		0.24~1.0 µH: ±20% 0.24~1.0 µH: ±20%
	MCHK2012		
	MCKK2012		0.24~1.0 μH: ±20%
	CK, LK, CKP, NM, MC Series	: 2~4MHz(CK16	808)
	Measuring frequency Measuring frequency	: 2~4MHz(CK16 : 2~25MHz(CK2	
	Measuring frequency	: 2~25MHz(CK2	
	Measuring frequency	: 10~25MHz(LK	
	Measuring frequency	: 1~50MHz(LK1	
	Measuring frequency	: 0.4~50MHz(LH	
	Measuring frequency		8 • CKP2012 • CKP2016 • CKP2520 • NM2012 • NM2520 • MCFK1608 • MCFE1608 • MCHK2012 • MCKK2012)
	Measuring equipment /jig		B+16092A(or its equivalent) •4195A+41951+16092A(or its equivalent)
	, 5.6		2A(or its equivalent) ·4291A+16193A(or its equivalent)/LK1005
			11A + 42842C + 42851 - 61100 (or its equivalent) / CKP1608 · CKP2012 · CKP2016 · CKP2520 · NM2012 ·
		NM2520 · MCF	K1608·MCFE1608·MCKK1608·MCHK2012·MCKK2012
Test Methods and	Measuring current	:•1mA rms (0.047	7~4.7 μH)
Remarks		•0.1mA rms(5.6	6~33 (H)
	HK、HKQ、AQ Series	0.1110 (0.0	0 00 July
	Measuring frequency	: 100MHz(HK060	03+HK1005+AQ105)
	Measuring frequency	: 50/100MHz(Hk	
	Measuring frequency		603S • HKQ0603U)
	Measuring frequency	: 300/500MHz(H	
	Measuring frequency	: 100/500MHz(H	
	Measuring equipment /jig	:•4291A+16197	A(or its equivalent)/HK0603·AQ105
		•4291A + 16193	3A(or its equivalent)/HK1005
			97A(or its equivalent)/HKQ0603S•HKQ0603U•HKQ0603W
			2A + in-house made jig(or its equivalent)/HK1608 · HK2125
		•E4991A+161	96D (or its equivalent) / HKQ0402

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0.0					
6. Q	BK0402				
	BK0603				
	BK1005				
	BKH0603				
	BKH1005				
	BK1608				
	BK2125				
	BK2010				
	ARRAY BK3216				
	BKP0402		<del> </del>		
	BKP0603				
	BKP1005				
	BKP1608				
	BKP2125				
	MCF 0605				
	MCF 0806				
	MCF 1210				
	MCF 2010				
	CK1608				
	CK2125	·			
	CKS2125				
Specified Value	CKP1608				
Spoomod Value	CKP2012		_		
	CKP2016				
	CKP2520				
	NM2012				
	NM2520				
	LK1005		10~20 min.		
	LK1608		10~35 min.		
	LK2125 HK0603		15~50 min.		
	HK1005		4~5 min.  8 min.		
	HK1608		8~12 min.		
	HK2125		10~18 min.		
	HKQ0402		3~8 min.		
	HKQ0603W		6~15 min.		
	HKQ0603S		10~13 min.		
	HKQ0603U		14 min.		
	AQ105		8 min.		
	MCFK1608				
	MCFE1608				
	MCKK1608		_		
	MCHK2012				
	MCKK2012				
	LK Series				
	Measuring frequency	: 10~25MHz(LK10 : 1~50MHz(LK160			
	Measuring frequency Measuring frequency	: 0.4~50MHz(LK160			
	Measuring requency  Measuring equipment /jig		H16092A(or its equivalent)		
	Weasuring equipment / Jig		16092A(or its equivalent)		
			(or its equivalent)		
			(or its equivalent)/LK1005		
	Measuring current	•1mA rms(0.047~	~4.7 µH)		
Test Methods and		•0.1mA rms(5.6~	γ33 μH)		
Remarks	HK、HKQ、AQ Series				
Nomano	Measuring frequency	: 100MHz(HK0603•			
	Measuring frequency	: 50/100MHz(HK16			
	Measuring frequency	: 500MHz (HKQ0603			
	Measuring frequency	: 300/500MHz(HKC : 100/500MHz(HKC			
	Measuring frequency Measuring equipment /jig		or its equivalent)/HK0603•AQ105		
			(or its equivalent)/HK1005		
			A(or its equivalent)/HKQ0603S+HKQ0603U+HKQ0603W		
			+ in-house made jig(or its equivalent)/HK1608, HK2125		
			D(or its equivalent)HKQ0402		
		· ·			

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7. DC Resistance							
	BK0402		0.07~1.2Ωmax.				
	BK0603		0.065∼1.50 Ω max.				
	BK1005		0.03~0.90 Ω max.				
	BKH0603		0.26~3.20 Ω max.				
	BKH1005		0.85~2.00 Ω max.				
	BK1608		0.05∼1.10Ω max.				
	BK2125		0.05~0.75Ω max.				
		BK2010	0.10~0.90Ω max.				
	ARRAY	BK3216	0.15~0.80 Ω max.				
	BKP0402		0.05~0.15 Ω max.				
	BKP0603		0.030~0.180Ω max.				
	BKP1005		0.0273~0.220Ω max.				
	BKP1608		0.025~0.18 Ω max.				
	BKP2125		0.020~0.075Ω max.				
	MCF 0605		2.5~5.0Ω max				
	MCF 0806		1.5~5.0 Ω max.				
	MCF 1210		1.5~4.5 Ω max.				
	MCF 2010		$4.5\Omega$ max.				
	CK1608		$0.45 \sim 0.85 \Omega(\pm 30\%)$				
	CK2125		0.16~0.65 Ω max.				
	CKS2125		0.12~0.52 Ω max.				
	CKP1608		0.15~0.35 Ω max.				
Specified Value	CKP2012		0.08~0.28 Ω max.				
	CKP2012		0.075~0.20 Ω max				
	CKP2520		0.05~0.16 Ω max.				
	NM2012		0.10~0.15 Ω max.				
	NM2520		0.11~0.22 Ω max.				
	LK1005		0.41 ~ 1.16 Ω max.				
	LK1608		$0.2\sim2.2\Omega$ max.				
	LK2125		0.2 × 2.2 x max. 0.1 ~ 1.1 Ω max.				
	HK0603		0.11~3.74Ω max.				
	HK1005		0.08~4.8Ω max.				
	HK1608		0.05~2.6 Ω max.				
			0.05~2.6 Ω max. 0.10~1.5 Ω max.				
	HK2125 HKQ0402		0.10~1.5 Ω max. 0.08~5.0 Ω max.				
	· ·						
	HKQ0603W		0.07~4.1 Ω max.				
	HKQ0603S		0.06~1.29 Ω max.				
	HKQ0603U		0.06~1.29 Ω max.				
	AQ105		0.07~0.45Ω max.				
	MCFK1608		0.050~0.224Ω max.				
	MCFE1608		0.100~0.340Ω max.				
	MCKK1608		0.038~0.123Ω max.				
	MCHK2012		0.024~0.111Ω max.				
	MCKK2012		0.025 ~ 0.090 Ω max.				
Test Methods and Remarks	Measuring equipm	ent:VOAC-7412, VOA	AC-7512, VOAC-7521 (made by Iwasaki Tsushinki), HIOKI3227 (or its equivalent)				

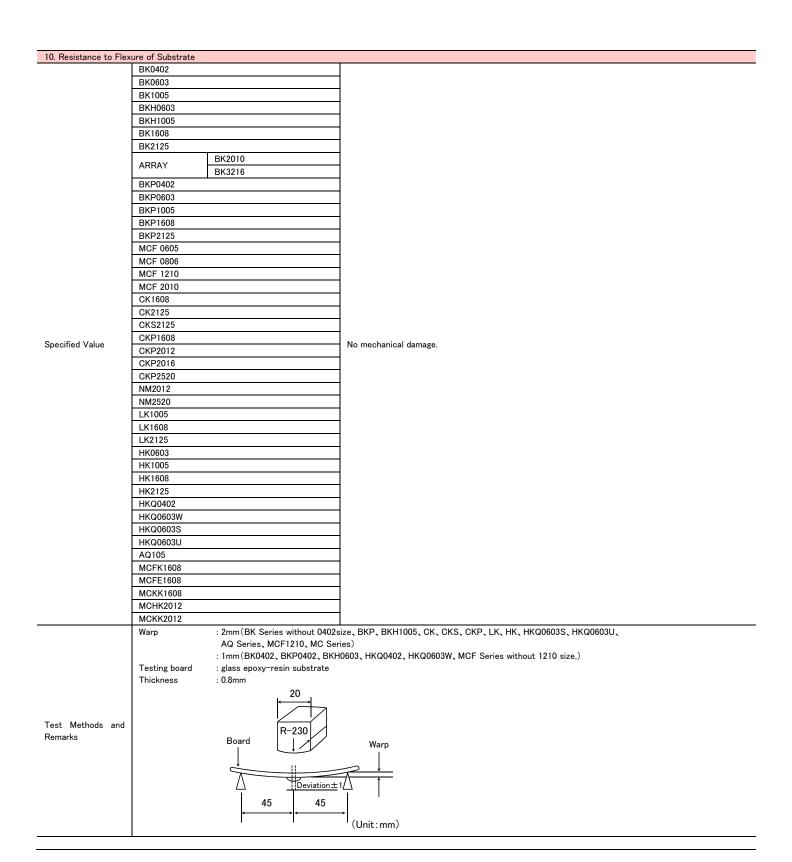
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8. Self Resonance Fre	quency(SRF)			
	BK0402			
	BK0603			
	BK1005			
	BKH0603			
	BKH1005			
	BK1608			
	BK2125			
		BK2010		
	ARRAY	BK3216		
	BKP0402	BROZIO		-
	BKP0603			
	BKP1005			
	BKP1608			
	BKP2125			
	MCF 0605			
	MCF 0806			
	MCF 0800			
	MCF 2010			17∼25MHz min.
	CK1608			
	CK2125			24~235MHz min.  24~75MHz min.
	CKS2125			24~75WHz min.
Specified Value	CKP1608			
	CKP2012			
	CKP2016			_
	CKP2520			
	NM2012			
	NM2520			
	LK1005			40~180MHz min.
	LK1608			9~260MHz min.
	LK2125			13~320MHz min.
	HK0603			900~10000MHz min.
	HK1005			400~10000MHz min.
	HK1608			300∼10000MHz min.
	HK2125			200∼4000MHz min.
	HKQ0402			1200∼10000MHz min.
	HKQ0603W			800∼10000MHz min.
	HKQ0603S			1900∼10000MHz min.
	HKQ0603U			1900~10000MHz min.
	AQ105			2300∼10000MHz min.
	MCFK1608			
	MCFE1608			
	MCKK1608			-
	MCHK2012			
	MCKK2012			
	LK, CK Series :			
Test Methods and	Measuring equip	oment	: 4195A (or its equiv	valent)
Remarks	Measuring jig		: 41951+16092A(o	r its equivalent)
· tomanto	HK, HKQ, AQ Se			
-				valent) • 8753D (or its equivalent) / HK2125

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9. Temperature Chara								
	BK0402							
	BK0603							
	BK1005							
	BKH0603							
	BKH1005							
	BK1608							
	BK2125							
	ARRAY	BK2010						
		BK3216						
	BKP0402							
	BKP0603							
	BKP1005							
	BKP1608							
	BKP2125							
	MCF 0605			_				
	MCF 0806							
	MCF 1210							
	MCF 2010							
	CK1608							
	CK2125							
	CKS2125							
Specified Value	CKP1608							
	CKP2012							
	CKP2016							
	CKP2520							
	NM2012							
	NM2520							
	LK1005							
	LK1608							
	LK2125							
	HK0603							
	HK1005							
	HK1608							
	HK2125							
	HKQ0402							
	HKQ0603W							
	HKQ0603S			Inductance change: Within ±10%				
	HKQ0603U			Industries strange that in a root				
	AQ105							
	MCFK1608							
	MCFE1608							
	MCKK1608							
	MCHK2012							
	MCKK2012							
	HK、HKQ、AQ Se							
<b>-</b>	Temperature ran		: −30~+85°C					
Test Methods and	Reference temp	perature	: +20°C					
Remarks	MC Series:		: −40~+85°C					
	Temperature ran Reference temp	-	: −40~+85 C : +20°C					
	oror orros comp		200					

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11. Solderability	I =1/0./00						
	BK0402						
	BK0603						
	BK1005		4				
	BKH0603		4				
	BKH1005						
	BK1608						
	BK2125						
	ARRAY	BK2010					
		BK3216					
	BKP0402						
	BKP0603						
	BKP1005						
	BKP1608						
	BKP2125						
	MCF 0605						
	MCF 0806						
	MCF 1210						
	MCF 2010						
	CK1608						
	CK2125						
	CKS2125						
Specified Value	CKP1608		At least 90% of terminal electrode is covered by new solder.				
Specified Value	CKP2012						
	CKP2016						
	CKP2520						
	NM2012						
	NM2520						
	LK1005						
	LK1608						
	LK2125						
	HK0603						
	HK1005						
	HK1608						
	HK2125						
	HKQ0402						
	HKQ0603W						
	HKQ0603S						
	HKQ0603U						
	AQ105						
	MCFK1608						
	MCFE1608						
	MCKK1608						
	MCHK2012						
	MCKK2012						
Toot Mothede and	Solder temperatu	ure : 230±5°C (JIS Z 32	282 H60A or H63A)				
Test Methods and Remarks	Solder temperatu	ure : 245±3°C (Sn/3.0A	.g/0.5Cu)				
Nemarks	Duration	:4±1 sec.					

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12. Resistance to Sold	_							
	BK0402							
	BK0603							
	BK1005							
	BKH0603							
	BKH1005							
	BK1608							
	BK2125			Appearance: No significant abnormality				
	ARRAY	BK2010		Impedance change:Within ±30%				
		BK3216						
	BKP0402							
	BKP0603							
	BKP1005							
	BKP1608							
	BKP2125							
	MCF 0605							
	MCF 0806			Appearance: No significant abnormality				
	MCF 1210			Impedance change: Within ±20%				
	MCF 2010							
	CK1608							
	CK2125			Appearance: No significant abnormality				
	CKS2125			Inductance change				
	CKP1608			R10~4R7: Within ±10%				
0 '6 17/1	CKP2012			6R8~100: Within ±15%				
Specified Value	CKP2016			CKS2125: Within ±20% CKP1608、CKP2012、CKP2016、CKP2520、NM2012、NM2520: Within ±30%				
	CKP2520							
	NM2012							
	NM2520			A N 1 100 A 1 100				
	LK1005			Appearance: No significant abnormality				
	I K1608			Inductance change: Within ±15%				
	LK1608			Appearance: No significant abnormality  Inductance change				
	LK2125			47N~4R7: Within ±10%				
				5R6~330: Within ±15%				
	HK0603							
	HK1005							
	HK1608							
	HK2125							
	HKQ0402			Appearance: No significant abnormality				
	HKQ0603W			Inductance change: Within ±5%				
	HKQ0603S							
	HKQ0603U							
	AQ105							
	MCFK1608							
	MCFE1608			A N 1 20 A 1 12				
	MCKK1608			Appearance: No significant abnormality				
	MCHK2012			Inductance change: Within ±10%				
	MCKK2012							
	Solder temperature : 260±5°C		:260±5°C					
	Duration		:10±0.5 sec.					
Test Methods and	Preheating tempe	erature :	:150 to 180°C					
Remarks	Preheating time		: 3 min.					
	Flux			methanol solution with colophony for 3 to 5 sec.				
(1) (1) 12"	Recovery			covery under the standard condition after the test.(See Note 1)				
(Note 1) When there a	(Note 1) When there are questions concerning measurement result; measurement shall be made after 48±2 hrs of recovery under the standard condition.							

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12 Th 1 Cl								
13. Thermal Shock	DKO400		1					
	BK0402							
	BK0603		-					
	BK1005		-					
	BKH0603		-					
	BKH1005		-					
	BK1608							
	BK2125	T =		gnificant abnormality				
	ARRAY	BK2010	Impedance change	Impedance change: Within ±30%				
		BK3216						
	BKP0402		-					
	BKP0603		-					
	BKP1005		-					
	BKP1608		-					
	BKP2125							
	MCF 0605							
	MCF 0806			gnificant abnormality				
	MCF 1210		Impedance change	: WITNIN ±20%				
	MCF 2010		A	20				
	CK1608			gnificant abnormality				
	CK2125		Inductance change: Within ±20% Q change: Within ±30%					
	CKS2125		Appearance: No significant abnormality Inductance change: Within ±20%					
Specified Value	CKP1608							
•	CKP2012		1					
	CKP2016		Appearance: No sig	gnificant abnormality				
	CKP2520		Inductance change					
	NM2012							
	NM2520							
	LK1005		Appearance: No significant abnormality					
	LK1608							
	LK2125		Inductance change: Within ±10% Q change: Within ±30%					
	HK0603		Appearance: No significant abnormality Inductance change: Within ±10% Q change: Within ±20%					
	HK1005							
	HK1608							
	HK2125							
	HKQ0402							
	HKQ0603W		inductance change	. Mulin ±1070 & Change. Mulin ±2070				
	HKQ0603S		]					
	HKQ0603U							
	AQ105		]					
	MCFK1608							
	MCFE1608		Annearance : No sis	gnificant abnormality				
	MCKK1608		Inductance change					
	MCHK2012			. main =1070				
	MCKK2012							
	Conditions for 1							
	Step	temperature(°C)		time (min.)				
	1	Minimum operating temperatur	e +0/-3	30±3				
Test Methods and	2	Room temperature		2~3				
Remarks	3	Maximum operating temperatur	re +3/-0	30±3				
	4	Room temperature		2~3				
	Number of cycle		al accordistant - O 1	test (See Note 1)				
	Recovery: 2 to 3 hrs of recovery under the standard condition after the test. (See Note 1)							

Recovery: 2 to 3 hrs of recovery under the standard condition after the test. (See Note 1)

(Note 1) When there are questions concerning measurement result; measurement shall be made after 48±2 hrs of recovery under the standard condition.

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14. Damp Heat (Stea							
	BK0402						
	BK0603						
	BK1005						
	BKH0603						
	BKH1005						
	BK1608						
	BK2125	Appearance: No significant abnormality					
	ARRAY BK2010	Impedance change: Within ±30%					
	BK3216						
	BKP0402						
	BKP0603						
	BKP1005						
	BKP1608						
	BKP2125						
	MCF 0605						
	MCF 0806	Appearance: No significant abnormality					
	MCF 1210	Impedance change: Within ±20%					
	MCF 2010	Account No. 100 Count do not the					
	CK1608	Appearance: No significant abnormality					
	CK2125	Inductance change: Within ±20% Q change: Within ±30%					
Specified Value	CKS2125	Appearance: No significant abnormality Inductance change: Within ±20%					
	CKP1608						
	CKP2012						
	CKP2016	Appearance: No significant abnormality					
	CKP2520	Inductance change: Within ±30%					
	NM2012						
	NM2520						
	LK1005	Appearance: No significant abnormality					
	LK1608	Inductance change: Within ±10% Q change: Within ±30%					
	LK2125	Appearance: No significant abnormality					
	HK0603	Inductance change: Within ±20% Q change: Within ±30%					
	HK1005						
	HK1608						
	HK2125	A No. of the last					
	HKQ0402	Appearance: No significant abnormality					
	HKQ0603W	Inductance change: Within ±10% Q change: Within ±20%					
	HKQ0603S						
	HKQ0603U						
	AQ105						
	MCFK1608						
	MCFE1608	Appearance: No significant abnormality					
	MCKK1608	Appearance: No significant abnormality  Inductance change: Within ±10%					
	MCHK2012	inductance change. Within ± 1070					
	MCKK2012						
<u> </u>	BK, BKP, BKH, LK, CK, CKS, (	KP, NM Series, MCF Series:					
	Temperature :40±2°C						
	Humidity : 90 to 95%F						
	Duration : 500 +24/-0						
Test Methods and	ods and Recovery :2 to 3 hrs of recovery under the standard condition after the removal from test chamber. (See Note 1)						
Remarks	HK, HKQ, AQ, MC Series:						
	Temperature : 60±2°C						
	Humidity :90 to 95%F	Н					
	Duration :500 +24/-0						
		recovery under the standard condition after the removal from test chamber.(See Note 1)					
(Note 1) When there a		ent result; measurement shall be made after 48±2 hrs of recovery under the standard condition.					
		•					

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15. Loading under Dan	i							
	BK0402		4					
	BK0603		<u> </u>					
	BK1005		<u> </u>					
	BKH0603		<u> </u>					
	BKH1005							
	BK1608							
	BK2125		Appearance: No significant abnormality					
	ARRAY	K2010	Impedance change: Within ±30%					
	В	K3216						
	BKP0402							
	BKP0603							
	BKP1005							
	BKP1608							
	BKP2125							
	CK1608		Appearance: No significant abnormality					
	CK2125		Inductance change: Within ±20% Q change: Within ±30%					
	CKS2125		Appearance: No significant abnormality					
	ONOZIZO		Inductance change: Within ±20%					
	CKP1608							
	CKP2012							
	CKP2016		Appearance: No significant abnormality					
	CKP2520		Inductance change: Within ±30%					
Specified Value	NM2012							
	NM2520							
	LK1005		Appearance: No significant abnormality					
	EKTOOO		Inductance change: Within ±10% Q change: Within ±30%					
			Appearance: No significant abnormality					
	LK1608		Inductance change: $0.047 \sim 12.0 \mu\text{H}$ : Within $\pm 10\%$ $15.0 \sim 33.0 \mu\text{H}$ : Within $\pm 15\%$					
			Q change: Within ±30%					
	LK2125		Appearance: No significant abnormality					
	LUCOCOC		Inductance change: Within ±20% Q change: Within ±30%					
	HK0603							
	HK1005							
	HK1608 HK2125							
			Appearance: No significant abnormality					
	HKQ0402		Inductance change: Within ±10% Q change: Within ±20%					
	HKQ0603W							
	HKQ0603S							
	HKQ0603U							
	AQ105							
	MCFK1608※		-					
	MCFE1608※		Appearance: No significant abnormality					
	MCKK1608※		Inductance change: Within ±10%					
	MCHK2012※ MCKK2012※		-					
		OK OKE OKE NIM C:						
	Temperature	CK、CKS、CKP、NM Series: :40±2°C						
	Humidity	: 90 to 95%RH						
	Applied current	: Rated current						
	Duration	:500 +24/-0 hrs						
	Recovery		der the standard condition after the removal from test chamber.(See Note 1)					
Test Methods and		o						
Remarks	HK, HKQ, AQ, MC S	Series:						
	Temperature	:60±2°C						
	Humidity	:90 to 95%RH						
	Applied current	:Rated current ※MC ser	ies ; Idc2max					
	Duration	:500 +24/-0 hrs						
	Recovery	:2 to 3 hrs of recovery un	der the standard condition after the removal from test chamber.(See Note 1)					
Make an akandandaan	Theoretic 2 - 2 to 9 miles or recovery tracer the standard condition area the removal nomines committee. (See Note 1)							

Note on standard condition: "standard condition" referred to herein is defined as follows:

5 to  $35^{\circ}\!\text{C}\,$  of temperature, 45 to 85% relative humidity, and 86 to 106kPa of air pressure.

When there are questions concerning measurement results:

In order to provide correlation data, the test shall be conducted under condition of  $20\pm2^{\circ}C$  of temperature, 60 to 70% relative humidity, and 86 to 106kPa of air pressure.

Unless otherwise specified, all the tests are conducted under the "standard condition."

(Note 1) Measurement shall be made after  $48\pm2$  hrs of recovery under the standard condition.

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16. Loading at High Te	mperature	
	BK0402	
	BK0603	
	BK1005	
	BKH0603	
	BKH1005	
	BK1608	
	BK2125	Appearance: No significant abnormality
	BK2010	Impedance change: Within ±30%
	ARRAY BK3216	
	BKP0402	
	BKP0603	
	BKP1005	
	BKP1608	
	BKP2125	
	MCF 0605	-
	MCF 0806	Appearance: No significant abnormality
	MCF 1210	Impedance change: Within ±20%
	MCF 2010	impedance change. Within ±2070
	CK1608	Appearance: No significant abnormality
	CK2125	Inductance change: Within ±20% Q change: Within ±30%
	GRZ123	Appearance: No significant abnormality
	CKS2125	Inductance change: Within ±20%
	CKP1608	inductance change. Within ±2070
	CKP2012	
Specified Value	CKP2012 CKP2016	Annayana Na simificant showns lity
Specified Value	CKP2520	Appearance: No significant abnormality Inductance change: Within ±30%
	NM2012	inductance change. Within ±3070
_		
	NM2520	Annayana Ma simificant shaquasitt
	LK1005	Appearance: No significant abnormality
		Inductance change: Within ±10% Q change: Within ±30%  Appearance: No significant abnormality
	LK1608	Inductance change: $0.047 \sim 12.0 \mu\text{H}$ : Within $\pm 10\%$ 15.0 $\sim 33.0 \mu\text{H}$ : Within $\pm 15\%$
	EKTOOO	Q change: Within ±30%
		Appearance: No significant abnormality
	LK2125	Inductance change: Within ±20% Q change: Within ±30%
	HK0603	and control of an agent that in the control of an angent that in the control of an agent that in the control of a control of
	HK1005	
	HK1608	
	HK2125	
	HKQ0402	Appearance: No significant abnormality
	HKQ0603W	Inductance change: Within ±10% Q change: Within ±20%
	HKQ0603S	
	HKQ0603U	
	AQ105	
	MCFK1608※	
	MCFE1608%	
	MCKK1608%	Appearance: No significant abnormality
	MCHK2012%	Inductance change: Within ±10%
	MCKK2012%	
Test Methods and Remarks	Temperature : Maximum operatin Applied current : Rated current X: Duration : 500 +24/-0 hrs	g temperature MC series ; Idc2max very under the standard condition after the removal from test chamber.

Note on standard condition: "standard condition" referred to herein is defined as follows:

5 to  $35^{\circ}\!C\,$  of temperature, 45 to 85% relative humidity, and 86 to 106kPa of air pressure.

When there are questions concerning measurement results:

In order to provide correlation data, the test shall be conducted under condition of  $20\pm2^{\circ}C$  of temperature, 60 to 70% relative humidity, and 86 to 106kPa of air pressure. Unless otherwise specified, all the tests are conducted under the "standard condition."

(Note 1) Measurement shall be made after  $48\pm2$  hrs of recovery under the standard condition.

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Precautions on the use of Multilayer chip inductors

Multilayer chip inductors for high frequency, Multilayer chip bead inductors

Multilayer common mode choke coils (MC series F type)

Metal Multilayer Chip Power Inductors (MCOIL<sup>TM</sup> MC series)

#### **PRECAUTIONS**

#### 1. Circuit Design

- ◆ Verification of operating environment, electrical rating and performance
  - 1. A malfunction in medical equipment, spacecraft, nuclear reactors, etc. may cause serious harm to human life or have severe social ramifications

#### Precautions

As such, any inductors to be used in such equipment may require higher safety and/or reliability considerations and should be clearly differentiated from components used in general purpose applications.

- ◆Operating Current(Verification of Rated current)
  - 1. The operating current including inrush current for inductors must always be lower than their rated values.
- 2. Do not apply current in excess of the rated value because the inductance may be reduced due to the magnetic saturation effect.

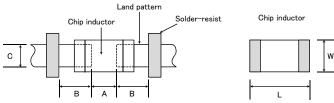
### 2. PCB Design

Precautions

- ◆Pattern configurations (Design of Land-patterns)
- 1. When inductors are mounted on a PCB, the size of land patterns and the amount of solder used (size of fillet) can directly affect inductor performance.

Therefore, the following items must be carefully considered in the design of solder land patterns:

- (1) The amount of solder applied can affect the ability of chips to withstand mechanical stresses which may lead to breaking or cracking. Therefore, when designing land-patterns it is necessary to consider the appropriate size and configuration of the solder pads which in turn determines the amount of solder necessary to form the fillets.
- (2) When more than one part is jointly soldered onto the same land or pad, the pad must be designed so that each component's soldering point is separated by solder-resist.
- (3) The larger size of land patterns and amount of solder, the smaller Q value after mounting on PCB. It makes higher the Q value to design land patterns smaller than terminal electrode of chips.
- ◆Pattern configurations (Inductor layout on panelized[ breakaway] PC boards)
  - After inductors have been mounted on the boards, chips can be subjected to mechanical stresses in subsequent manufacturing processes (PCB cutting, board inspection, mounting of additional parts, assembly into the chassis, wave soldering the reflow soldered boards etc.) For this reason, planning pattern configurations and the position of SMD inductors should be carefully performed to minimize stress.
- ◆Pattern configurations(Design of Land-patterns)
  - The following diagrams and tables show some examples of recommended patterns to prevent excessive solder amounts (larger fillets
    which extend above the component end terminations). Examples of improper pattern designs are also shown.
    - (1) Recommended land dimensions for a typical chip inductor land patterns for PCBs



Recommended land dimensions for wave-soldering (Unit:mm)

Ту	ре	1608	2012	2125	2016	2520	3216	
Size	L	1.6	2.0	2.0 2.0		2.5	3.2	
Size	W	0.8	1.25	1.25	1.6	2.0	1.6	
A	١	0.8~1.0	1.0~1.4	1.0~1.4	1.0~1.4	1.0~1.4	1.8~2.5	
Е	3	0.5~0.8	0.8~1.5	0.8~1.5	0.8~1.5	0.6~1.0	0.8~1.7	
С		0.6~0.8	0.9~1.2	0.9~1.2	1.3~1.6	1.6~2.0	1.2~1.6	

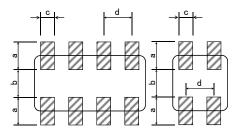
# Technical considerations

Recommended land dimensions for reflow-soldering (Unit:mm)

T	уре	0402	0603	1005	105	1608	2012	2125	2016	2520	3216
Size	L	0.4	0.6	1.0	1.0	1.6	2.0	2.0	2.0	2.5	3.2
Size	W	0.2	0.3	0.5	0.6	0.8	1.25	1.25	1.6	2.0	1.6
	A	0.15~0.25	0.20~0.30	0.45~0.55	0.50~0.55	0.8~1.0	0.8~1.2	0.8~1.2	0.8~1.2	1.0~1.4	1.8~2.5
	В	0.10~0.20	0.20~0.30	0.40~0.50	0.30~0.40	0.6~0.8	0.8~1.2	0.8~1.2	0.8~1.2	0.6~1.0	0.6~1.5
	С	0.15~0.30	0.25~0.40	0.45~0.55	0.60~0.70	0.6~0.8	0.9~1.6	0.9~1.6	1.2~2.0	1.8~2.2	1.2~2.0

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Excess solder can affect the ability of chips to withstand mechanical stresses. Therefore, please take proper precautions when designing land-patterns.



Recommended land dimension for Reflow-soldering

Туре		3216	2010	1210	0806	0605
C:	┙	3.2	2.0	1.25	0.85	0.65
Size	W	1.6	1.0	1.0	0.65	0.50
а	1	0.7~0.9	0.5~0.6	0.45~0.55	0.25~0.35	0.27~0.33
b	)	0.8~1.0	0.5~0.6	0.7~0.8	0.25~0.35	0.17~0.23
С		0.4~0.5	0.2~0.3	0.25~0.35	0.25~0.35	0.20~0.26
d		0.8	0.5	0.55	0.5	0.4

(Unit:mm)

((2) Examples of good and bad solder application

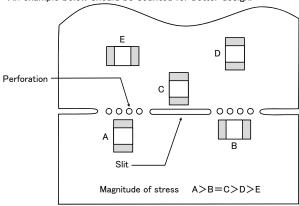
۷.	2) Examples of good and bad solder application				
	Item	Not recommended	Recommended		
	Mixed mounting of SMD and leaded components	Lead wire of component	Solder-resist		
	Component placement close to the chassis	Chassis Solder (for grounding) Electrode pattern	Solder-resist		
	Hand-soldering of leaded components near mounted components	Lead wire of component Soldering iron	Solder-resist -		
	Horizontal component placement		Solder-resist		

- ◆Pattern configurations (Inductor layout on panelized[ breakaway] PC boards)
  - 1-1. The following are examples of good and bad inductor layout; SMD inductors should be located to minimize any possible mechanical stresses from board warp or deflection.

Item	Not recommended	Recommended	
Deflection of the board		Position the component at a right angle to the direction of the mechanical stresses that are anticipated.	of

1-2. To layout the inductors for the breakaway PC board, it should be noted that the amount of mechanical stresses given will vary depending on inductor layout.

An example below should be counted for better design.



1-3. When breaking PC boards along their perforations, the amount of mechanical stress on the inductors can vary according to the method used. The following methods are listed in order from least stressful to most stressful: push-back, slit, V-grooving, and perforation. Thus, any ideal SMD inductor layout must also consider the PCB splitting procedure.

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#### 3. Considerations for automatic placement

- ◆Adjustment of mounting machine
  - 1. Excessive impact load should not be imposed on the inductors when mounting onto the PC boards.
  - 2. The maintenance and inspection of the mounter should be conducted periodically.

#### Precautions

#### ◆Selection of Adhesives

- 1. Mounting inductors with adhesives in preliminary assembly, before the soldering stage, may lead to degraded inductor characteristics unless the following factors are appropriately checked; the size of land patterns, type of adhesive, amount applied, hardening temperature and hardening period. Therefore, it is imperative to consult the manufacturer of the adhesives on proper usage and amounts of adhesive to use.
- ◆Adjustment of mounting machine
  - 1. If the lower limit of the pick-up nozzle is low, too much force may be imposed on the inductors, causing damage. To avoid this, the following points should be considered before lowering the pick-up nozzle:
    - The lower limit of the pick-up nozzle should be adjusted to the surface level of the PC board after correcting for deflection of the board.
    - (2) The pick-up pressure should be adjusted between 1 and 3N static loads.
    - (3) To reduce the amount of deflection of the board caused by impact of the pick-up nozzle, supporting pins or back-up pins should be used under the PC board. The following diagrams show some typical examples of good pick-up nozzle placement:

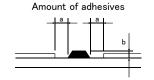
Item	Improper method	Proper method	
Single-sided mounting	chipping or cracking	supporting pins or back-up pins	
Double-sided mounting	chipping or cracking	supporting pins or back-up pins	

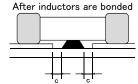
# Technical considerations

- 2. As the alignment pin wears out, adjustment of the nozzle height can cause chipping or cracking of the inductors because of mechanical impact on the inductors. To avoid this, the monitoring of the width between the alignment pin in the stopped position, and maintenance, inspection and replacement of the pin should be conducted periodically.
- ◆Selection of Adhesives
  - 1. Some adhesives may cause reduced insulation resistance. The difference between the shrinkage percentage of the adhesive and that of the inductors may result in stresses on the inductors and lead to cracking. Moreover, too little or too much adhesive applied to the board may adversely affect component placement, so the following precautions should be noted in the application of adhesives.
    - (1) Required adhesive characteristics
      - a. The adhesive should be strong enough to hold parts on the board during the mounting & solder process.
      - b. The adhesive should have sufficient strength at high temperatures.
      - c. The adhesive should have good coating and thickness consistency.
      - d. The adhesive should be used during its prescribed shelf life.
      - e. The adhesive should harden rapidly.
      - f. The adhesive must not be contaminated.
      - g. The adhesive should have excellent insulation characteristics.
      - h. The adhesive should not be toxic and have no emission of toxic gasses.
    - (2) When using adhesives to mount inductors on a PCB, inappropriate amounts of adhesive on the board may adversely affect component placement. Too little adhesive may cause the inductors to fall off the board during the solder process. Too much adhesive may cause defective soldering due excessive flow of adhesive on to the land or solder pad.

#### [Recommended conditions]

Figure	0805 case sizes as examples
а	0.3mm min
b	100∼120 μm
С	Area with no adhesive





#### 4. Soldering

Precautions

#### ◆Selection of Flux

- 1. Since flux may have a significant effect on the performance of inductors, it is necessary to verify the following conditions prior to use;
  - (1) Flux used should be with less than or equal to 0.1 wt% (Chlorine conversion method) of halogenated content. Flux having a strong acidity content should not be applied.
  - (2) When soldering inductors on the board, the amount of flux applied should be controlled at the optimum level.
  - (3) When using water-soluble flux, special care should be taken to properly clean the boards.

#### ◆Soldering

1. Temperature, time, amount of solder, etc. are specified in accordance with the following recommended conditions, and please contact us about peak temperature when you use lead-free paste.

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#### ◆Selection of Flux

- 1-1. When too much halogenated substance (Chlorine, etc.) content is used to activate the flux, or highly acidic flux is used, an excessive amount of residue after soldering may lead to corrosion of the terminal electrodes or degradation of insulation resistance on the surface of the Inductor.
- 1-2. Flux is used to increase solderability in flow soldering, but if too much is applied, a large amount of flux gas may be emitted and may detrimentally affect solderability. To minimize the amount of flux applied, it is recommended to use a flux-bubbling system.
- 1-3. Since the residue of water-soluble flux is easily dissolved by water content in the air, the residue on the surface of Inductor in high humidity conditions may cause a degradation of insulation resistance and therefore affect the reliability of the components. The cleaning methods and the capability of the machines used should also be considered carefully when selecting water-soluble flux.

#### Soldering

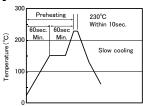
#### 1-1. Preheating when soldering

Heating: Chip inductor components should be preheated to within  $100 \text{ to } 130^{\circ}\text{C}$  of the soldering. Cooling: The temperature difference between the components and cleaning process should not be greater than  $100^{\circ}\text{C}$ .

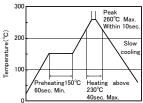
Chip inductors are susceptible to thermal shock when exposed to rapid or concentrated heating or rapid cooling. Therefore, the soldering process must be conducted with a great care so as to prevent malfunction of the components due to excessive thermal shock.

#### [Reflow soldering]

#### [Recommended conditions for eutectic soldering]



#### [Recommended condition for Pb-free soldering]



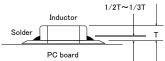
- %Ceramic chip components should be preheated to within 100 to 130°C of the soldering.
- \*Assured to be reflow soldering for 2 times.
- \*MC series; Peak 230°C(eutectic soldering), 260°C(Pb-free soldering)max within 5sec.

#### Caution

Technical

considerations

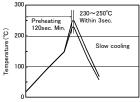
1. The ideal condition is to have solder mass (fillet) controlled to 1/2 to 1/3 of the thickness of the inductor, as shown below:



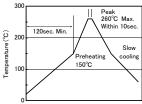
2. Because excessive dwell times can detrimentally affect solderability, soldering duration should be kept as close to recommended times as possible.

#### [Wave soldering]

#### [Recommended conditions for eutectic soldering]



#### [Recommended condition for Pb-free soldering]



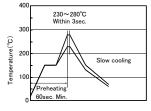
- $\mbox{\%}$ Ceramic chip components should be preheated to within 100 to 130°C of the soldering.
- XAssured to be wave soldering for 1 time.
- Except for reflow soldering type.

#### Caution

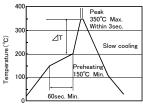
- 1. Make sure the inductors are preheated sufficiently.
- 2. The temperature difference between the inductor and melted solder should not be greater than 100 to  $130^{\circ}\text{C}$ .
- 3. Cooling after soldering should be as gradual as possible.
- 4. Wave soldering must not be applied to the inductors designated as for reflow soldering only.

#### [Hand soldering]

#### [Recommended conditions for eutectic soldering



#### [Recommended condition for Pb-free soldering]



- (**※**⊿T≦190°C( 3216Type max), ⊿T≦130°C( 3225 Type min)
- $\times$ It is recommended to use 20W soldering iron and the tip is 1  $\phi$  or less.
- \*The soldering iron should not directly touch the components.
- \*Assured to be soldering iron for 1 time

Note: The above profiles are the maximum allowable soldering condition, therefore these profiles are not always recommended.

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## Caution 1. Use a 20W soldering iron with a maximum tip diameter of 1.0 mm. 2. The soldering iron should not directly touch the inductor.

### 5. Cleaning ◆Cleaning conditions 1. When cleaning the PC board after the Inductors are all mounted, select the appropriate cleaning solution according to the type of flux Precautions

used and purpose of the cleaning (e.g. to remove soldering flux or other materials from the production process.) 2. Cleaning conditions should be determined after verifying, through a test run, that the cleaning process does not affect the inductor's

characteristics. Cleaning conditions

> 1. The use of inappropriate solutions can cause foreign substances such as flux residue to adhere to the inductor, resulting in a degradation of the inductor's electrical properties (especially insulation resistance).

2. Inappropriate cleaning conditions (insufficient or excessive cleaning) may detrimentally affect the performance of the inductors.

(1) Excessive cleaning

a. In the case of ultrasonic cleaning, too much power output can cause excessive vibration of the PC board which may lead to the cracking of the inductor or the soldered portion, or decrease the terminal electrodes' strength. Thus the following conditions should be carefully checked:

Ultrasonic output Below 20W/Q Ultrasonic frequency Below 40kHz 5 min. or less Ultrasonic washing period

#### 6. Post cleaning processes

◆Application of resin coatings, moldings, etc. to the PCB and components.

### Precautions

**Technical** 

considerations

- 1. With some type of resins a decomposition gas or chemical reaction vapor may remain inside the resin during the hardening period or while left under normal storage conditions resulting in the deterioration of the inductor's performance.
- 2. When a resin's hardening temperature is higher than the inductor's operating temperature, the stresses generated by the excess heat may lead to inductor damage or destruction.
- 3. Stress caused by a resin's temperature generated expansion and contraction may damage inductors.

The use of such resins, molding materials etc. is not recommended.

#### 7. Handling

- ◆Breakaway PC boards (splitting along perforations)
  - 1. When splitting the PC board after mounting inductors and other components, care is required so as not to give any stresses of deflection or twisting to the board.
  - 2. Board separation should not be done manually, but by using the appropriate devices.
- General handling precautions
  - 1. Always wear static control bands to protect against ESD.
  - 2. Keep the inductors away from all magnets and magnetic objects.
- 3. Use non-magnetic tweezers when handling inductors. Precautions
  - 4. Any devices used with the inductors (soldering irons, measuring instruments) should be properly grounded.
  - 5. Keep bare hands and metal products (i.e., metal desk) away from chip electrodes or conductive areas that lead to chip electrodes.
  - 6. Keep inductors away from items that generate magnetic fields such as speakers or coils.
  - Mechanical considerations
  - 1. Be careful not to subject the inductors to excessive mechanical shocks.
    - (1) If inductors are dropped on the floor or a hard surface they should not be used.
    - (2) When handling the mounted boards, be careful that the mounted components do not come in contact with or bump against other boards or components.

#### 8. Storage conditions

# temperature and humidity in the storage area. Humidity should especially be kept as low as possible.

#### Recommended conditions

Ambient temperature: Below 30°C Humidity: Below 70% RH

The ambient temperature must be kept below 40°C. Even under ideal storage conditions, solderability of inductor is deteriorated as time passes, so inductors should be used within 6 months from the time of delivery.

1. To maintain the solderability of terminal electrodes and to keep the packaging material in good condition, care must be taken to control

•Inductor should be kept where no chlorine or sulfur exists in the air.

#### Technical considerations

Precautions

#### ◆Storage

1. If the parts are stocked in a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place. For this reason, components should be used within 6 months from the time of delivery. If exceeding the above period, please check solderability before using the inductors.

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